

Work package / task	Work package / task leader	Institution
2 Improved Standard Cavity Fabrication (ISCF)	<i>P. Michelato</i>	INFN Mi
2.1 Reliability analysis	L. Lilje	DESY
2.2 Improved component design	P. Michelato	INFN Milano
2.3 EB welding	J. Tiessen	DESY
3 Seamless Cavity Production (SCP)	<i>W.-D. Moeller</i>	DESY
3.1 Seamless cavity production by spinning	E. Palmieri	INFN LNL
3.2 Seamless cavity production by hydroforming	W. Singer	DESY
4 Thin Film Cavity Production (TFCP)	<i>M. Sadowski</i>	IPJ
4.1 Linear arc cathode	P. Strzyzewski	IPJ
4.2 Planar arc cathode	S. Tazzari	INFN Roma2
5 Surface Preparation (SP)	<i>A. Matheisen</i>	DESY
5.1 EP on single cells	F. Eozenou	CEA
5.2 EP on multicells	N. Steinhilber-Kühl	DESY
5.3 Automated EP	E. Palmieri	INFN LNL
5.4 Dry ice cleaning	D. Reschke	DESY
6 Material Analysis (MA)	<i>E. Palmieri</i>	INFN LNL
6.1 Squid scanning	W. Singer	DESY
6.2 Flux gate magnetometry	M. Valentino	INFN LNL
6.3 DC field emission studies of Nb samples	X. Singer	DESY
7 Couplers (COUP)	<i>A. Variola</i>	IN2P3-Orsay
7.1 New proto-types	L. Grandsire	IN2P3-Orsay
7.2 Titanium-nitride coating system	L. Grandsire	IN2P3-Orsay
7.3 Conditioning studies	P. Lepercq	IN2P3-Orsay
8 Tuners (TUN)	<i>P. Sekalski</i>	TUL
8.1 UMI Tuner	A. Bosotti	INFN-Milano
8.2 Magnetostrictive Tuner	A. Grecki	TUL
8.3 CEA Tuner	P. Bosland	CEA
8.4 IN2P3 activities	M. Fouaidy	IN2P3 Orsay
9 Low Level RF (LLRF)	<i>S. Simrock</i>	DESY
9.1 Operability and Technical performance	S. Simrock	DESY
9.2 Cost and reliability	M. Grecki	TUL
9.3 Hardware technology	R. Romaniuk	WUT-ISE
9.4 Software technology	T. Jezynski	WUT-ISE
10 Cryostat Integration Tests	<i>B. Visentin</i>	CEA/DSM/DAPNIA
11 Beam Diagnostics (BD)	<i>M. Castellano</i>	INFN-Frascati
11.1 Beam position monitor	C. Simon	CEA/DSM/DAPNIA
11.2 Emittance monitor	C. Simon	CEA
11.3 HOM beam position monitor	O. Napoly	IN2P3-Orsay